BT134W series D

GENERAL DESCRIPTION

Glass passivated, sensitive gate triacs in a plastic envelope suitable for surface mounting, intended for use in general purpose bidirectional phase switching and control applications. These devices are intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

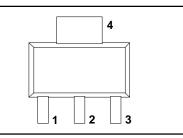
QUICK REFERENCE DATA

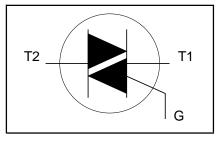
SYMBOL	PARAMETER	MAX.	MAX.	UNIT
V _{drm} I _{t(rms)} I _{tsm}	BT134W- Repetitive peak off-state voltages RMS on-state current Non-repetitive peak on-state current	500D 500 1 10	600D 600 1 10	V A A

PIN CONFIGURATION

SYMBOL

PIN	DESCRIPTION
1	main terminal 1
2	main terminal 2
3	gate
tab	main terminal 2





LIMITING VALUES

PINNING - SOT223

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MA	UNIT	
V _{drm}	Repetitive peak off-state voltages		-	-500 500 ¹	-600 600 ¹	V
I _{T(RMS)} I _{TSM}	RMS on-state current Non-repetitive peak on-state current	full sine wave; $T_{sp} \le 108$ °C full sine wave; $T_j = 25$ °C prior to surge	-		1	A
		t = 20 ms	-		0	A
l ² t	I ² t for fusing	t = 16.7 ms t = 10 ms	-		1 .5	A A ² s
dl _⊤ /dt	Repetitive rate of rise of on-state current after	$I_{TM} = 1.5 \text{ A}; I_G = 0.2 \text{ A};$ $dI_G/dt = 0.2 \text{ A}/\mu\text{s}$		0	.0	
	triggering	T2+G+	-		0	A/μs
		T2+G-	-		0	A/µs
		T2- G- T2- G+			0 0	A/μs A/μs
I _{GM}	Peak gate current		-		2	Å
V _{GM}	Peak gate voltage		-	Į	5	V
PGM	Peak gate power		-			W
$\begin{array}{c} P_{G(AV)} \\ T_{stg} \\ T_{j} \end{array}$	Average gate power Storage temperature Operating junction temperature	over any 20 ms period	- -40 -	1:	.5 50 25	°℃ ℃

¹ Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 3 A/µs.

Triacs

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THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
	Thermal resistance junction to solder point	full or half cycle	-	-	15	K/W
R _{th i-a}	Thermal resistance	pcb mounted; minimum footprint pcb mounted; pad area as in fig:14	-	156 70	-	K/W K/W

STATIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

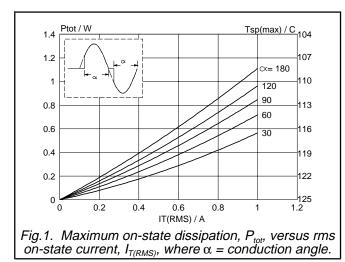
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{GT}	Gate trigger current	$V_{\rm D} = 12 \text{ V}; \text{ I}_{\rm T} = 0.1 \text{ A}$				
01		T2+	G+ -	2.0	5	mA
		T2+	G	2.5	5	mA
		T2-	G	2.5	5	mA
		T2-	G+ -	5.0	10	mA
I,	Latching current	$V_{\rm D} = 12 \text{ V}; I_{\rm GT} = 0.1 \text{ A}$				
-		T2+	G+ -	1.6	10	mA
		T2+	G	4.5	15	mA
		T2-	G	1.2	10	mA
		T2-	G+ -	2.2	15	mA
I _H	Holding current	$V_{\rm D} = 12 \text{ V}; I_{\rm GT} = 0.1 \text{ A}$	-	1.2	10	mA
I _H V _T V _{GT}	On-state voltage	$I_T = 2 A$	-	1.2	1.5	V
V _{GT}	Gate trigger voltage	$V_{\rm P} = 12 \text{ V}$: $I_{\rm T} = 0.1 \text{ A}$	-	0.7	1.5	V
		$V_{\rm D} = 400 \text{ V}; I_{\rm T} = 0.1 \text{ A}; T_{\rm i} = 125 \text{ °C}$	0.25	0.4	-	V
I _D	Off-state leakage current	$V_{D}^{i} = 400 \text{ V}; I_{T} = 0.1 \text{ A}; T_{j} = 125 \text{ °C}$ $V_{D} = V_{DRM(max)}; T_{j} = 125 \text{ °C}$	-	0.1	0.5	mA

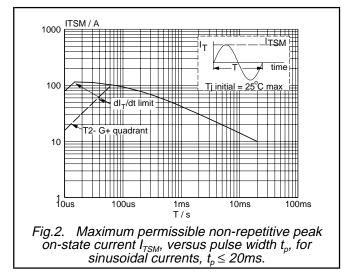
DYNAMIC CHARACTERISTICS

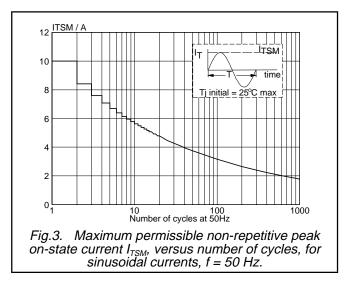
 $T_i = 25$ °C unless otherwise stated

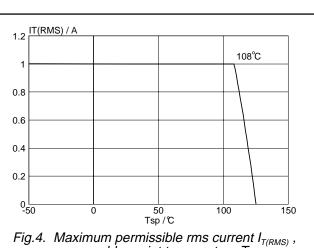
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
dV _D /dt	Critical rate of change of	$V_{DM} = 67\% V_{DRM(max)}; T_j = 125 °C;$	-	5	-	V/µs
t _{gt}		exponential waveform; $R_{GK} = 1 \ k\Omega$ $I_{TM} = 1.5 \ A$; $V_D = V_{DRM(max)}$; $I_G = 0.1 \ A$; $dI_G/dt = 5 \ A/\mu s$	-	2	-	μs

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versus solder point temperature T_{sp} .

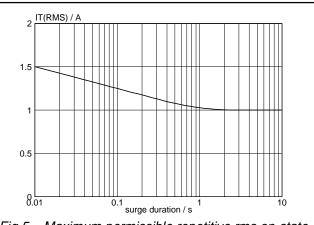
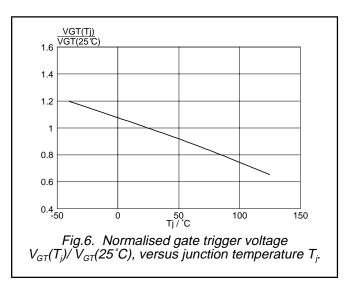
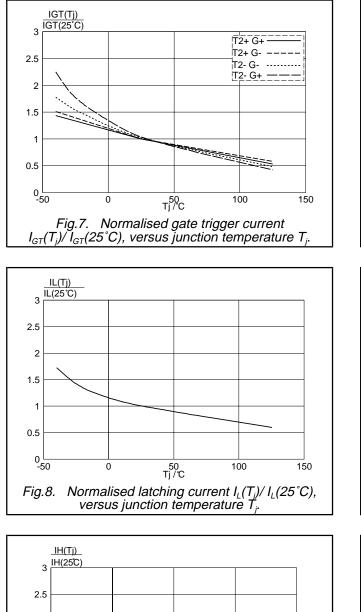
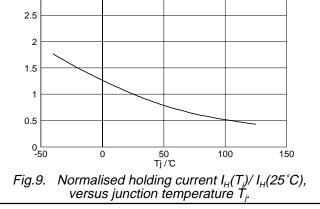


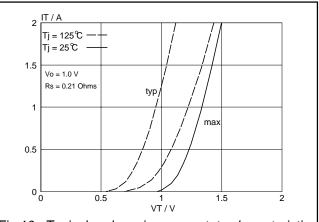
Fig.5. Maximum permissible repetitive rms on-state current $I_{T(RMS)}$, versus surge duration, for sinusoidal currents, f = 50 Hz; $T_{sp} \le 108$ °C.

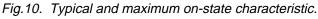


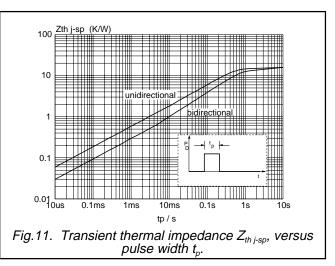
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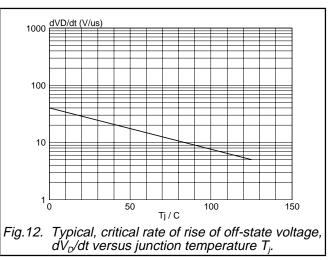






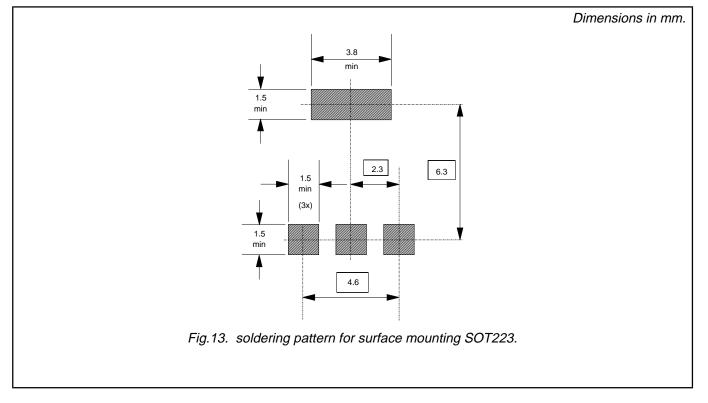




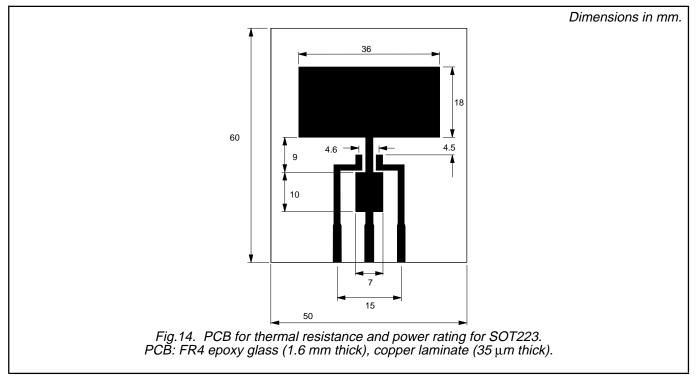


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MOUNTING INSTRUCTIONS

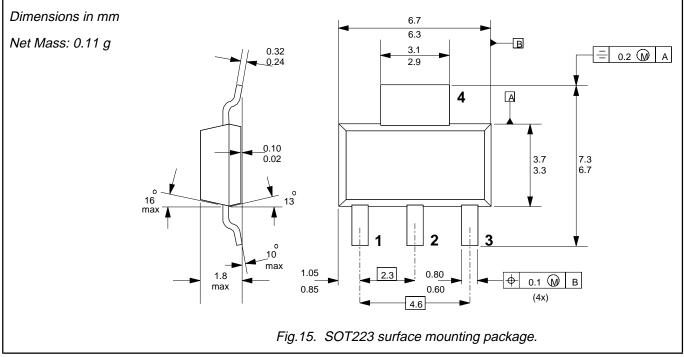


PRINTED CIRCUIT BOARD



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MECHANICAL DATA



Notes

For further information, refer to Philips publication SC18 " SMD Footprint Design and Soldering Guidelines". Order code: 9397 750 00505.
Epoxy meets UL94 V0 at 1/8".

Triacs	BT134W series D
logic level	

DEFINITIONS

Data sheet status					
Objective specification This data sheet contains target or goal specifications for product development.					
Preliminary specification	Preliminary specification This data sheet contains preliminary data; supplementary data may be published later.				
Product specification	This data sheet contains final product specifications.				
Limiting values					
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.					
Application information					
Where application information is given, it is advisory and does not form part of the specification.					

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